

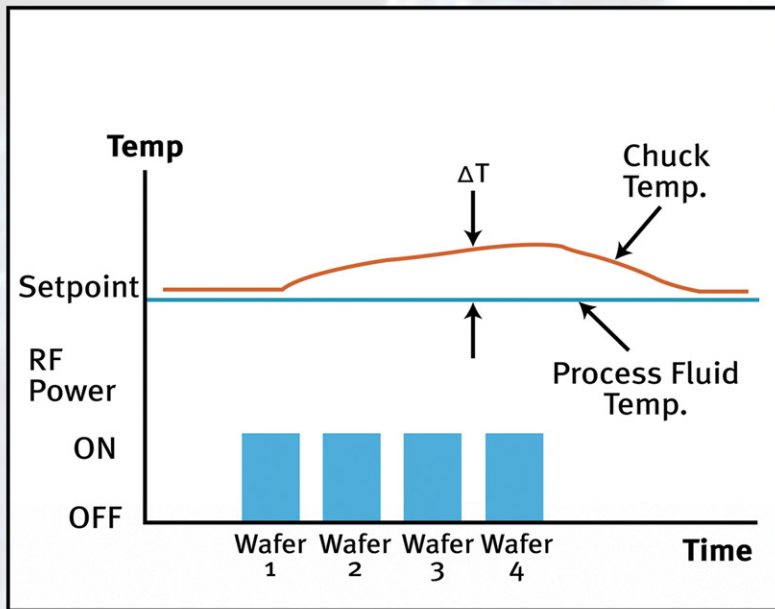
Experience the POU evolution

dynamic temperature control * smallest footprint in the industry enables POU installations
 lowest power consumption * sub-floor tile mount capability * zero temperature drift
 reliable solid-state operation & only one moving part * multi-platform interfacing capability
 only 1 gallon of coolant required * synchronized with the process

process improvement & comparison



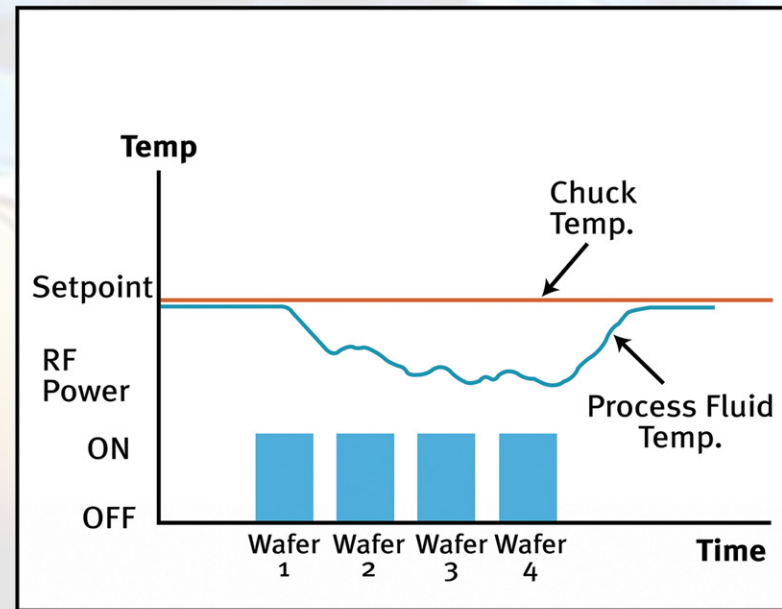
conventional



temperature drift

- negative effect on side wall passivation
- wafer-to-wafer temperature instability
- reservoir fluid temperature constant
- chuck temperature varies
- unstable etch rates

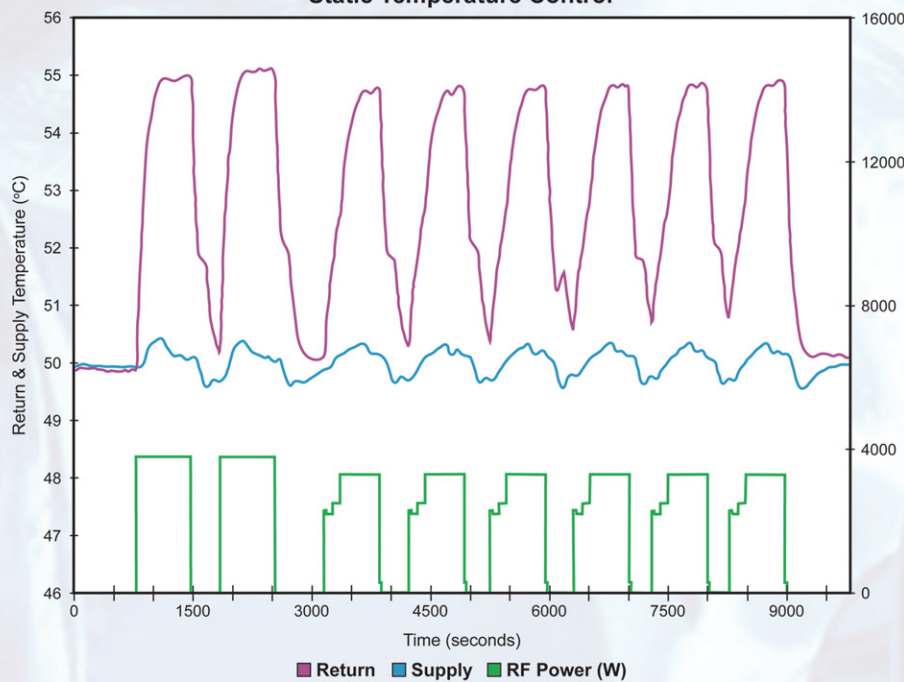
POU



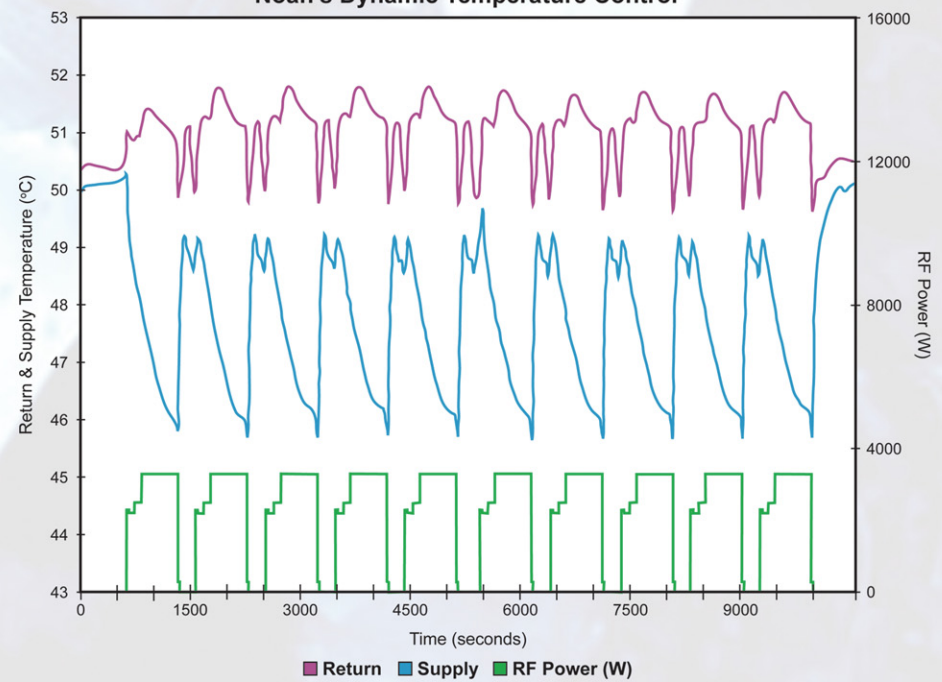
improved control

- fluid supplied temperature varies
- chuck temperature constant
- reduced 'First Wafer Effect'
- wafer-to-wafer stability
- improved CD bias
- stable etch profile

Static Temperature Control



Noah's Dynamic Temperature Control



NOAH PRECISION, LLC

sales@noahprecision.com • service@noahprecision.com • www.noahprecision.com